

Product Technical Data Sheet

PRODUCENT: AG Termopasty Grzegorz Gąsowski
ul. Kolejowa 33 E, 18-218 Sokóły, tel. 86 274 13 42

SILICONE FILLING COMPOUND 011 TWO-COMPONENT FOR ELECTRICAL PURPOSES

The product is a liquid encapsulating compound, two-component. Crosslinks in the condensation system. Curing takes place at room temperature. The material provides a low expansion. Ideal for encapsulating or filling gaps in electronic components with metal enclosures. Has an excellent fluidity when dosing and encapsulating. After curing it does not detach due to the cyclic heating from the surface to which it adheres. The cured product is dry to the touch.

Characteristics (before cross-linking):

Properties	Filling compound
Consistency	liquid
Colour	transparent
Viscosity (cP)	2000 ± 500
pH	6 to 8
Catalyst dose (weight part per 100 weight parts of filling compound)	8

Application:

Encapsulation of electronic/electrical systems. Energy converters. Power semiconductors. Power supplies. Automotive electronics. Motion control. Telecommunication. Computers and peripheral devices.

The application of condensation filling compound in a closed system can cause the occurrence of unarmful white coating, which does not influence on the operation of the system.

Preparation of filling compound:

The use of silicone filling compound of 011 type is to prepare the filling composition and the system, and then fill the system and season it for approximately 24 hours at a room temperature.

To do this:

1. Weigh filling compound 011 in a dry and clean vessel having a volume 5 times the volume of weighed silicone. Vessels with special requirements are not required; e.g. plastic vessels can be applied.

We do not recommend weighing large amount of filling compound. It may be the reason for extending the time of each operation, i.e. the time of mixing the components (filling compound with the catalyst), the time of venting of the composition, the filling time with a prepared mass, which in turn may lead to hardening of the composition in a vessel, in which it is prepared.

2. Weigh a recommended dose of the catalyst.
3. Mix the ingredients.

The catalyst must be uniformly distributed throughout the mass, because it influences on the completed protection quality.

It is recommended to place the prepared composition in a vacuum chamber (30-60 mm Hg) to vent it. During this procedure, which should be short (no more than 5 minutes), firstly, the composition foams, and increases its original volume to approx. 5 times, then it returns to the parent volume (output); if this has occurred, turn off vacuum and remove the vessel from the chamber with the composition being ready to use.

It is also possible to make a protection with a composition that has not been subjected to venting in the vacuum chamber. In this case, the end result depends inter alia on the type and diligence of a making person.

Systems protection:

Before filling, clean, degrease and dry the system. Such prepared system should be placed in a housing or a form and filled with the composition, then leave the system open to be cross-linked, and season for approx. 100 hours. Air circulation is very important, because during cross-linking, ethyl alcohol is separated, which must be freed from a hardened mass, otherwise adverse phenomenon of reversion can occur. In the event of e.g. under-filling, one can cut out pieces of rubber (filling compound), and re-fill such places. In addition, in the case of damage of filled electronic components, one can cut out surrounding filling compound, and after replacing, re-fill the composition of the same kind.

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Filling compound properties (after cross-linking):

No.	Parameter	Unit	Silicone filling compound 011
1	Density at 25°C, not less than	[g/cm ³]	0,97
2	Content of volatiles, not more than	[%]	3
3	Usability time from the time of addition of 8 weight parts of the catalyst (per 100 weight parts of filling compound), not less than	[minutes]	30
4	Geling time from the time of addition of 8 weight parts of Catalyst (per 100 weight parts of Filling compound), not more than	[hours]	48
5	PH of aqueous extract	-	7 ± 1
Test of cross-linking samples, seasoning for at least 100 hours at a room temperature from a hardening time			
6	Cross resistivity at 20 ± 5°C and air relative humidity of 65 ± 5%, not less than	[ohm·cm]	1 x 10 ¹²
7	Surface resistivity at 20 ± 5°C and air relative humidity of 65 ± 5%, not less than	[Ohm]	1 x 10 ¹³
8	Dielectric loss factor (tan δ) at a frequency of 10 ⁶ Hz, not more than	-	0,005
9	Dielectric permeability at a frequency of 10 ⁶ Hz, not more than	-	3
10	Dielectric durability at 20 ± 5°C and air relative humidity of 65 ± 5%, not less than	[kV/mm]	10
11	Thermal resistance	[°C]	from -50 to 200
12	Resistance to creepage currents in accordance with PN-EN 60112:2003 (CTI)	[V]	600
13	Hardness based on Shore scale	[A]	26

Packagings:

Volume	Collective packaging	Item Code
100g + 8g	2	ART.AGT-219

Warehousing:

Store in original packaging in dry warehouses, at a temperature not higher than 30°C.

Guarantee period: 12 months from the production date.

Data contained in this document are consistent with the current state of our knowledge. They describe typical product properties and applications. However, it is up to the user to examine the suitability of this product for specific applications. We deny liability for the obtained results on the grounds that application conditions lie beyond our control.